



Total Dose Effects on HfO₂ based Ge MOS capacitors

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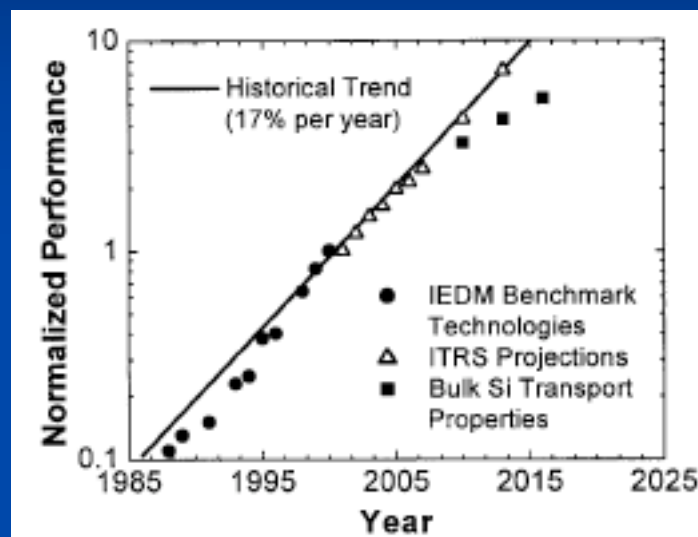
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Motivation

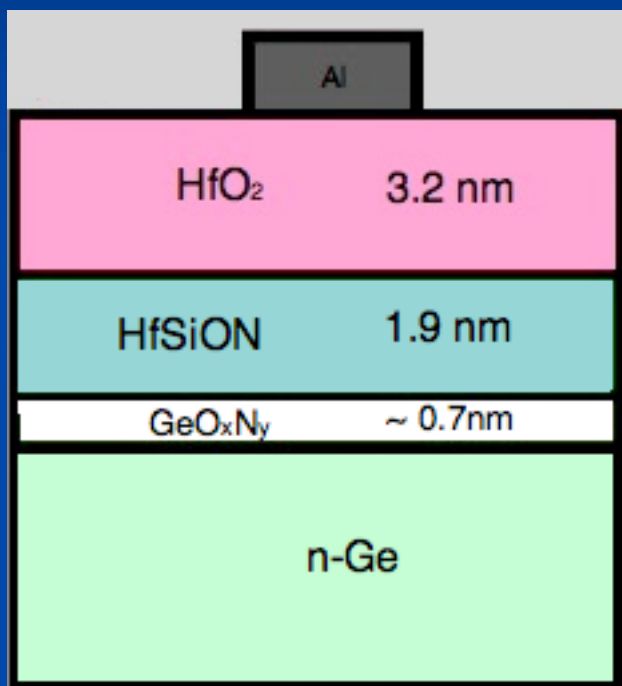


- Germanium has higher and more symmetric electron & hole mobilities than Si
- Smaller bandgap
- High-k possible on Ge
- Radiation response



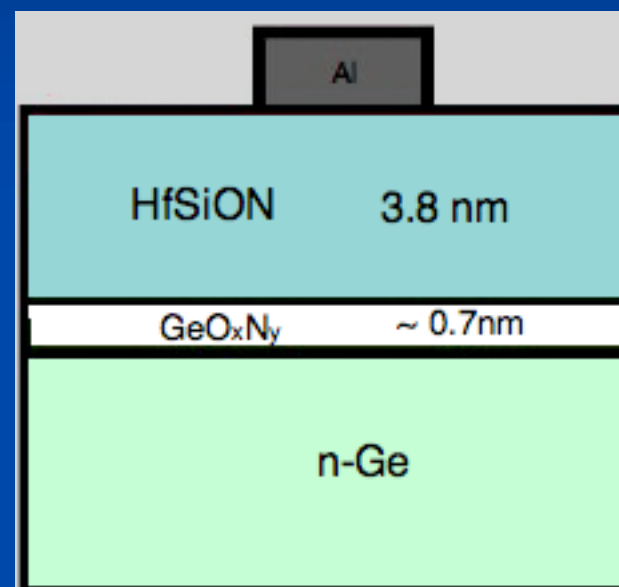
Device details

(with HfO₂)



HfO₂/HfSiON/Ge

- Higher C_{ox}

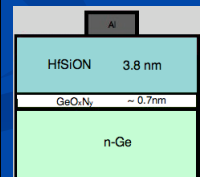
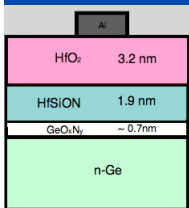
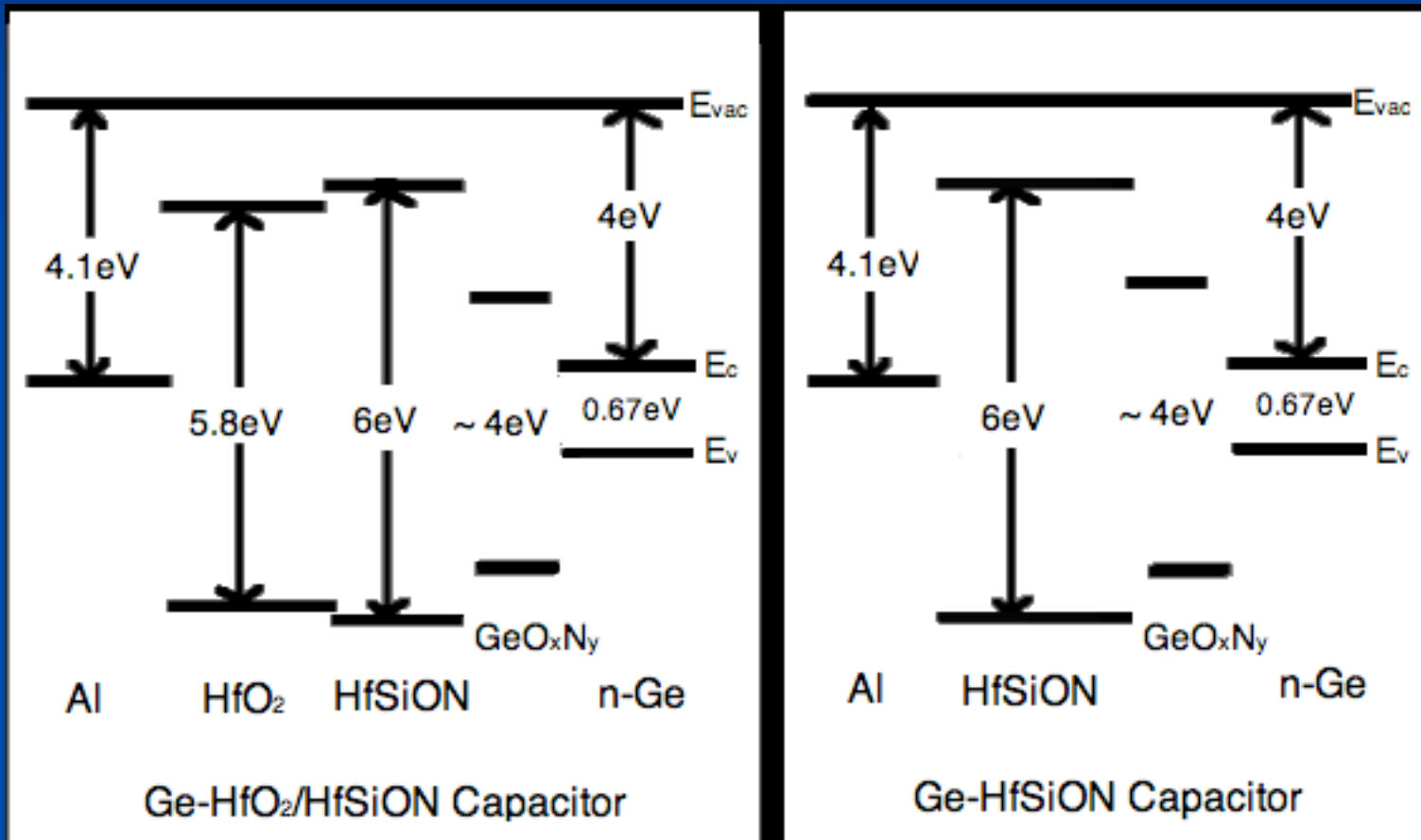


HfSiON/Ge

- Smaller C_{ox}
- Better radiation response

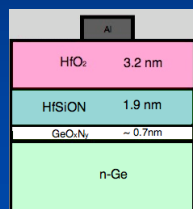


Energy Band Diagram

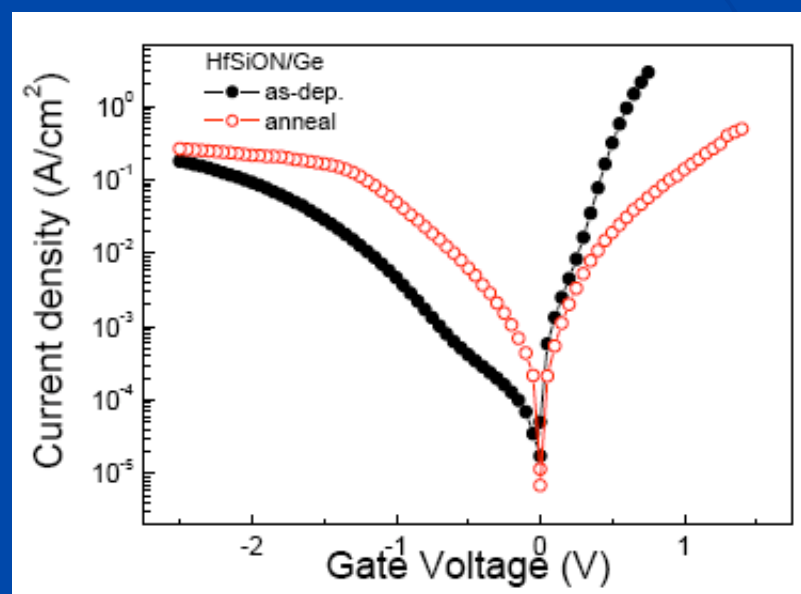
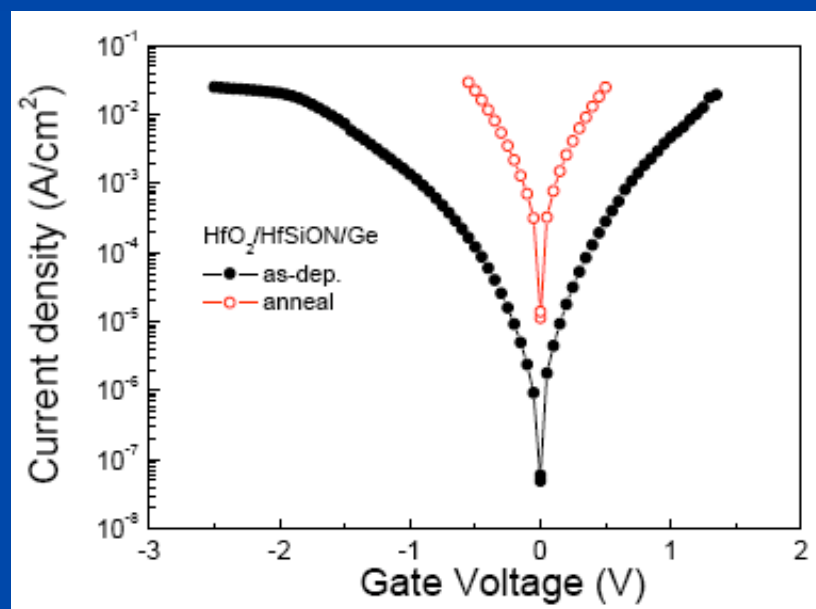
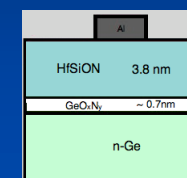




Gate Currents



(with HfO₂)



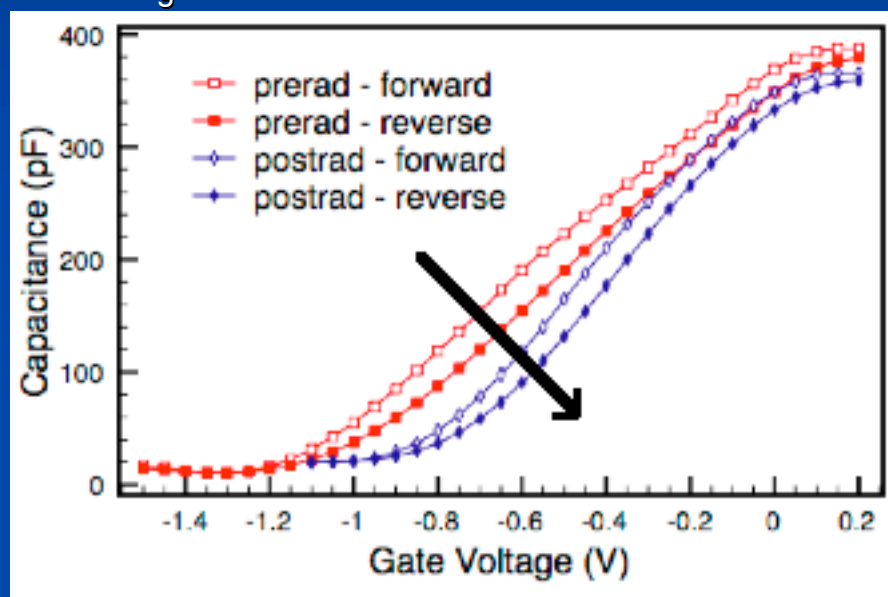
Problem of leakage currents in Germanium devices



Radiation results

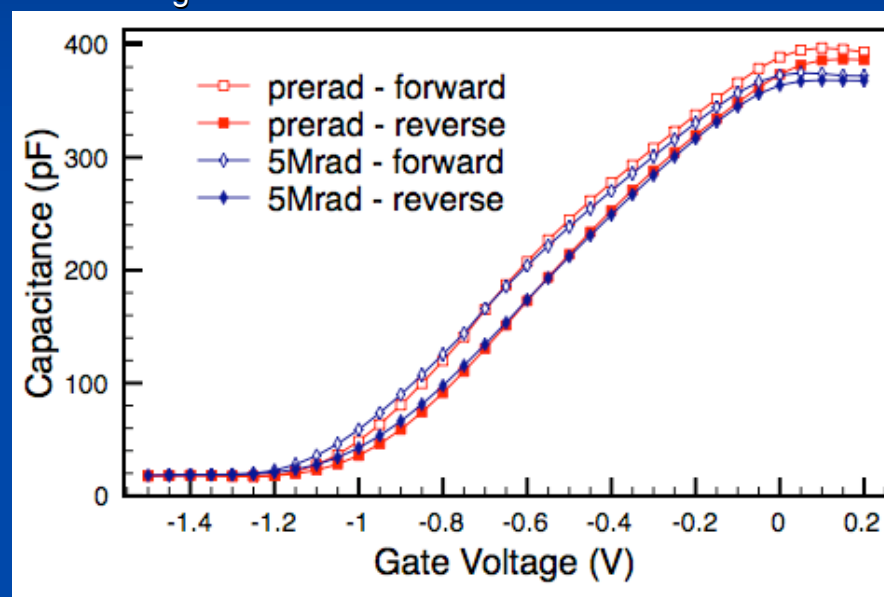
A
HfO ₂ 3.2 nm
HfSiON 1.9 nm
GeO ₂ N _x ~ 0.7nm
n-Ge

$V_g > 0$ (During irradiation)



- biased device - formation of interface traps and oxide traps

$V_g = 0$ (During irradiation)



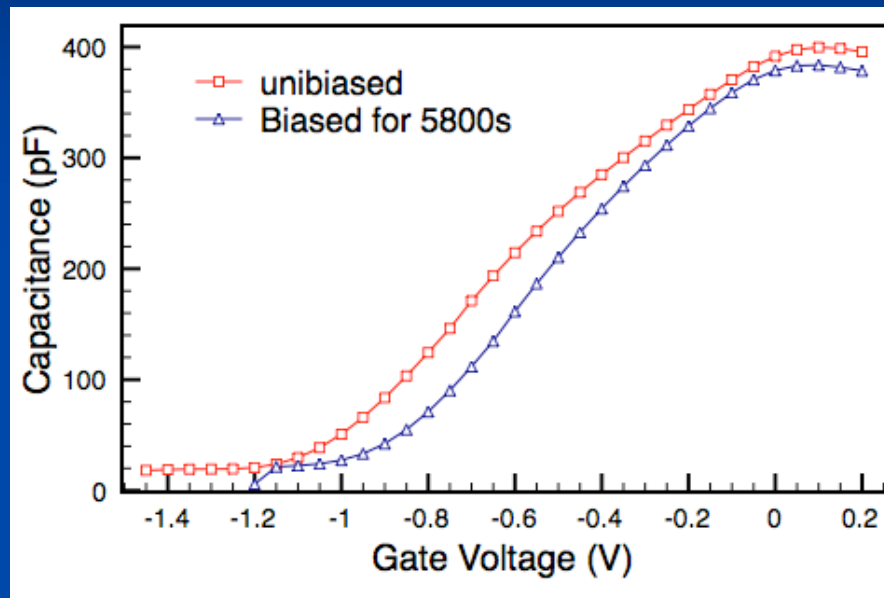
- unbiased device - not a lot of oxide/border traps though it shows some stretch-out ~ 50mV

Devices radiated at 31.5 krad(SiO₂)/min, C-V at 1MHz



Constant Voltage Stress

A	
HfO ₂	3.2 nm
HfSiON	1.9 nm
GeO ₂ N _x	~0.7nm
n-Ge	



(with HfO₂)

$$V_g > 0$$

- Major oxide trap shift due to bias
- Radiation did induce interface traps
- Large gate current of the order of 1 A/cm². So another possibility is that the gate leakage current is neutralizing some of the radiation induced charges

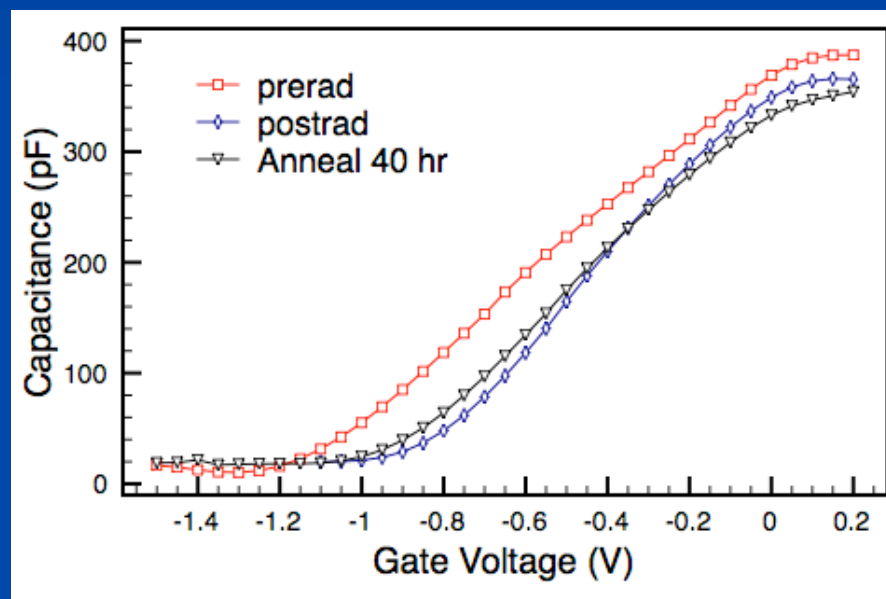


Anneal Measurements

Al	
HfO ₂	3.2 nm
HfSiON	1.9 nm
GeO ₂ N _x	~ 0.7nm
n-Ge	

(with HfO₂)

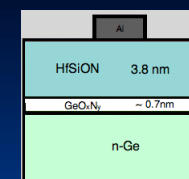
$V_g > 0$ (During radiation)



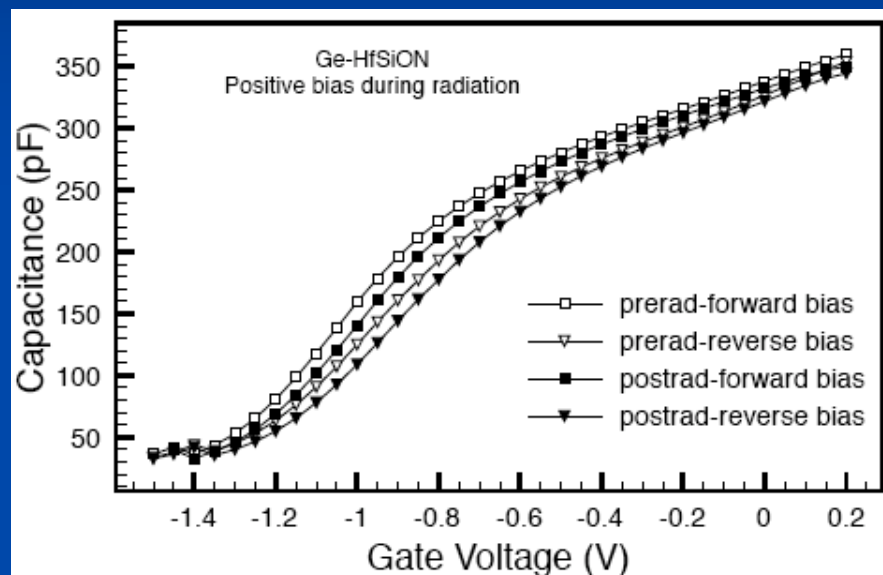
C-V shifted back near 3Mrad values for the biased device.



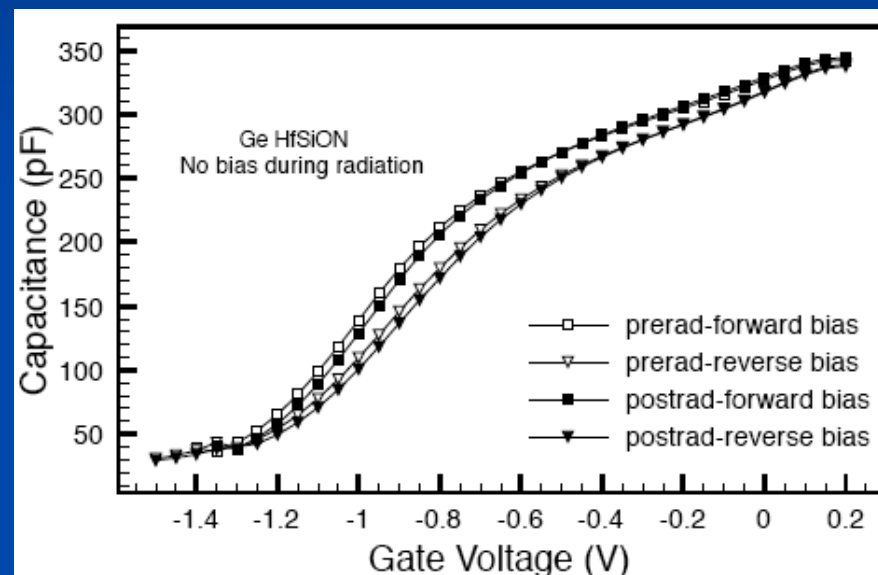
Ge-HfSiON



$V_g > 0$ (During irradiation)



$V_g = 0$ (During irradiation)



- hysteresis shows presence of border traps
- positive bias radiation - shift. Due to the bias and not radiation as shown in HfO₂/HfSiON/Ge system

- no bias radiation - no shift in C-V



Conclusion

- High-k dielectrics possible on Ge.
- The dielectrics show hysteresis and effect of bias.
- HfSiON/Ge capacitors show a little better radiation and bias response than HfO₂/HfSiON/Ge capacitor. But HfO₂/HfSiON/Ge capacitors have higher accumulation capacitance value and lower leakage.
- HfSiON seems to be a good interface on top of which higher dielectric constant oxide can be grown without sacrificing radiation response.